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(54) Title: RESIN MOLDED ARTICLE WITH REDUCED DIELECTRIC LOSS TANGENT AND PRODUCTION METHOD THEREFOR

(57) Abstract: A resin molded article having a reduced dielectric loss tangent is provided. This resin molded article is obtained by performing a heat treatment to a resin composition comprising a liquid-crystalline polyester and an epoxy-group containing ethylene copolymer at a temperature lower than a flow-beginning temperature of the liquid-crystalline polyester, preferably at a temperature between a lower limit temperature calculated by subtracting 120°C from the flow-beginning temperature and an upper limit temperature calculated by subtracting 20°C from the flow-beginning temperature. This resin molded article has a smaller dielectric loss tan



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